Docket No.

248983US2DIV

IN RE APPLICATION OF: Michiaki HIYOSH

SERIAL NO: 10/780,644

FILED:

February 19, 2004

FOR:

HERMETICALLY SEALED SEMICONDUCTOR POWER MODULE AND LARGE SCALE MODULE

COMPRISING THE SAME

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

## SIR:

Transmitted herewith is an amendment under 37 CFR §1.312 in the above-identified application.

- No additional fee is required
- ☐ Small entity status of this application under 37 C.F.R. §1.9 and §1.27 is claimed.
- ☐ Additional documents filed herewith:

The Fee has been calculated as shown below:

CLAIMS	CLAIMS REMAINING		HIGHEST NUMBER PREVIOUSLY PAID	NO. EXTRA CLAIMS		RATE		CALCULATIONS
TOTAL	5	MINUS	20	0	х	\$50	=	\$0.00
INDEPENDENT	1	MINUS	3	0	х	\$200	=	\$0.00
		☐ MULTIPL	E DEPENDENT	CLAIMS	+	\$360	=	\$0.00
			TOTAL	OF ABOVE CA	LCI	JLATIC	NS	\$0.00
		☐ Reduction	by 50% for filing	by Small Entity				\$0.00
		☐ Recordatio	n of Assignment		+	\$40	=	\$0.00
						ТОТ	`AL	\$0.00

☐ A check in the amount of \$0.00 is attach
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- ☐ Credit card payment form is attached to cover the fees in the amount of **§0.00**
- Please charge any additional Fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.
- If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136, and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

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Carl E. Schlier

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WAR 22 DUS TO

DOCKET NO: 248983US2DIV

## IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

: EXAMINER: DOUGLAS W. OWENS

MICHIAKI HIYOSHI

SERIAL NO: 10/780,644

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FILED: FEBRUARY 19, 2004

: GROUP ART UNIT: 2811

FOR: HERMETICALLY SEALED SÉMICONDUCTOR POWER MODULE AND LARGE SCALE MODULE

COMPRISING THE SAME

## AMENDMENT UNDER 37 CFR §1.312

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Notice of Allowance dated January 18, 2005, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.